

Single, Dual, and Quad Micropower, Low Drift, RRIO Operational Amplifiers

ISL28130, ISL28230, ISL28430

The ISL28130, ISL28230 and ISL28430 are single, dual and quad micropower, low drift operational amplifiers that are optimized for single and dual supply operation from 1.65V to 5.5V and $\pm 0.825V$ to $\pm 2.75V$. Their low supply current of 20 μA and wide input range enable the ISL28130, ISL28230, ISL28430 to be an excellent general purpose op amp for a range of applications. The ISL28130, ISL28230 and ISL28430 are ideal for handheld devices that operate off 2 AA or single Li-ion batteries.

The ISL28130 is available in industry standard pinouts for 5 Ld SOT-23, 5 Ld SC70 and 8 Ld SOIC packages. The ISL28230 is available in industry standard pinouts for 8 Ld MSOP and 8Ld SOIC packages. The ISL28430 is available in 14 Ld TSSOP and 14 Ld SOIC packages. All devices operate over the temperature range of 0°C to +70°C.

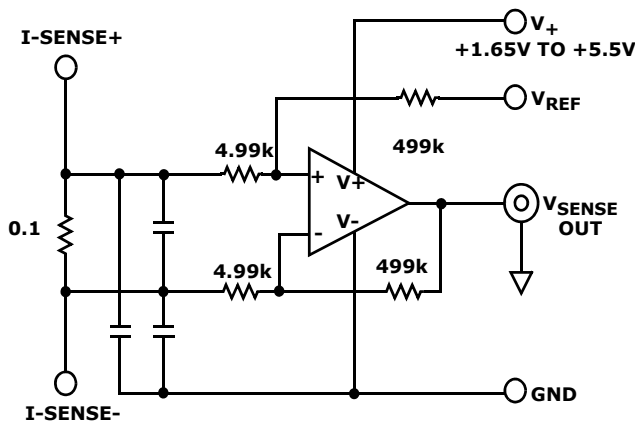
Features

- Low Input Offset Voltage 40 μV , Max.
- Low Offset Drift 150nV/°C, Max
- Input Bias Current 250 pA, Max.
- Quiescent Current (Per Amplifier) 20 μA , Typ.
- Single Supply Range +1.65V to +5.5V
- Dual Supply Range $\pm 0.825V$ to $\pm 2.75V$
- Low Noise (0.01Hz to 10Hz) 1.1 μV_{p-p} , Typ.
- Rail-to-Rail Inputs and Output
- Operating Temperature Range 0°C to +70°C

Applications* (see page 11)

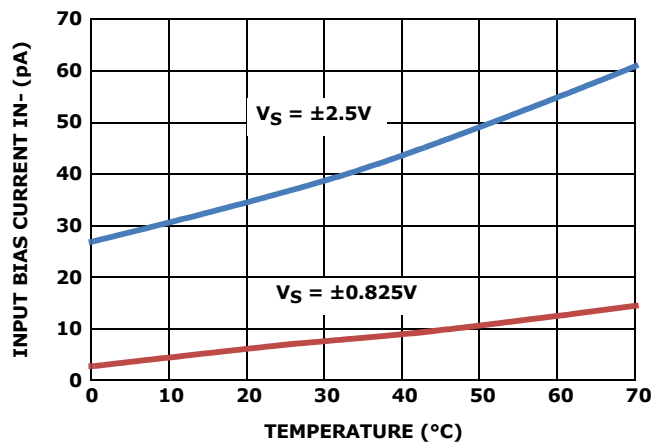
- Bi-Directional Current Sense
- Temperature Measurement
- Medical Equipment
- Electronic Weigh Scales
- Precision/Strain Gauge Sensor
- Precision Regulation
- Low Ohmic Current Sense
- High Gain Analog Front Ends

Typical Application



BI-DIRECTIONAL CURRENT SENSE AMPLIFIER

I_B vs Temperature



Ordering Information

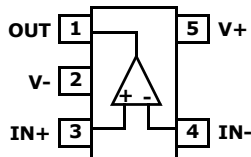
PART NUMBER (Notes 2, 3)	PART MARKING	PACKAGE (Pb-Free)	PKG. DWG. #
<i>Coming Soon</i> ISL28130CBZ	28130 CBZ	8 Ld SOIC	M8.15E
<i>Coming Soon</i> ISL28130CBZ-T7 (Note 1)	28130 CBZ	8 Ld SOIC (Tape & Reel)	M8.15E
<i>Coming Soon</i> ISL28130CBZ-T7A (Note 1)	28130 CBZ	8 Ld SOIC (Tape & Reel)	M8.15E
ISL28130CHZ-T7 (Note 1)	BDPA (Bottom Brand)	5 Ld SOT-23 (Tape & Reel)	P5.064A
ISL28130CHZ-T7A (Note 1)	BDPA (Bottom Brand)	5 Ld SOT-23 (Tape & Reel)	P5.064A
ISL28130CEZ-T7 (Note 1)	BLA (Bottom Brand)	5 Ld SC70 (Tape & Reel)	P5.049
ISL28130CEZ-T7A (Note 1)	BLA (Bottom Brand)	5 Ld SC70 (Tape & Reel)	P5.049
ISL28230CUZ	8230Z	8 Ld MSOP	M8.118A
ISL28230CUZ-T7 (Note 1)	8230Z	8 Ld MSOP (Tape & Reel)	M8.118A
ISL28230CUZ-T7A (Note 1)	8230Z	8 Ld MSOP (Tape & Reel)	M8.118A
ISL28230CBZ	28230 CBZ	8 Ld SOIC	M8.15E
ISL28230CBZ-T7 (Note 1)	28230 CBZ	8 Ld SOIC (Tape & Reel)	M8.15E
ISL28230CBZ-T7A (Note 1)	28230 CBZ	8 Ld SOIC (Tape & Reel)	M8.15E
ISL28430CBZ	28430 CBZ	14 Ld SOIC	MDP0027
ISL28430CBZ-T7 (Note 1)	28430 CBZ	14 Ld SOIC (Tape & Reel)	MDP0027
ISL28430CBZ-T7A (Note 1)	28430 CBZ	14 Ld SOIC (Tape & Reel)	MDP0027
ISL28430CVZ	28430 CVZ	14 Ld TSSOP	MDP0044
ISL28430CVZ-T7A (Note 1)	28430 CVZ	14 Ld TSSOP (Tape & Reel)	MDP0044
ISL28430CVZ-T13 (Note 1)	28430 CVZ	14 Ld TSSOP (Tape & Reel)	MDP0044

NOTES:

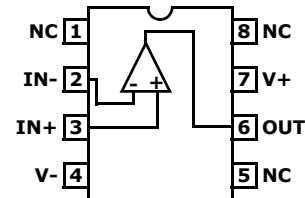
1. Please refer to [TB347](#) for details on reel specifications.
2. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
3. For Moisture Sensitivity Level (MSL), please see device information page for [ISL28130](#), [ISL28230](#), [ISL28430](#). For more information on MSL please see techbrief [TB363](#).

Pin Configurations

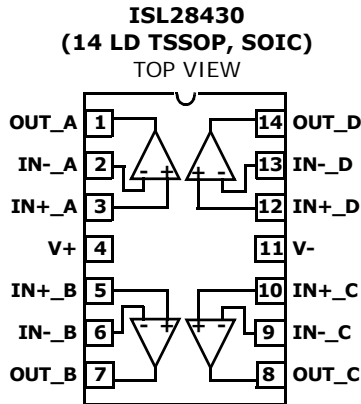
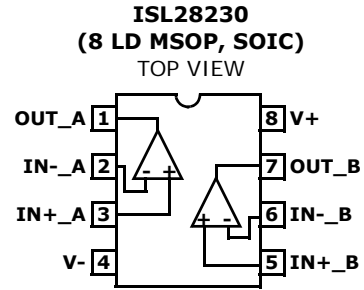
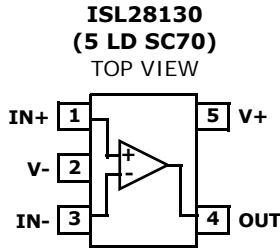
ISL28130
(5 LD SOT-23)
TOP VIEW



ISL28130
(8 LD SOIC)
TOP VIEW



Pin Configurations (Continued)



Pin Descriptions

ISL28130 (5 Ld SOT23)	ISL28130 (8 Ld SOIC)	ISL28130 (5 LD SC70)	PIN NAME	FUNCTION	EQUIVALENT CIRCUIT
3	3	1	IN+	Non-inverting input	<p>Circuit 1</p>
2	4	2	V-	Negative supply	
4	2	3	IN-	Inverting input	(See "Circuit 1")
1	6	4	OUT	Output	<p>Circuit 2</p>
5	7	5	V+	Positive supply	
	1, 5, 8		NC	Not Connected – This pin is not electrically connected internally.	

ISL28130, ISL28230, ISL28430

Pin Descriptions

ISL28230 (8 Ld MSOP, SOIC)	ISL28430 (14 Ld TSSOP, SOIC)	PIN NAME	FUNCTION	EQUIVALENT CIRCUIT
3	3	IN+_A	Non-inverting input	<p style="text-align: center;">Circuit 1</p>
5	5	IN+_B		
	10	IN+_C		
	12	IN+_D		
4	11	V-	Negative supply	
2	2	IN-_A	Inverting input	(See Circuit 1)
6	6	IN-_B		
	9	IN-_C		
	13	IN-_D		
1	1	OUT_A	Output	<p style="text-align: center;">Circuit 2</p>
7	7	OUT_B		
	8	OUT_C		
	14	OUT_D		
8	4	V+	Positive supply	

ISL28130, ISL28230, ISL28430

Absolute Maximum Ratings

Max Supply Voltage V+ to V-	6.5V
Max Voltage VIN to GND (V- - 0.3V) to (V+ + 0.3V)V	
Max Input Differential Voltage	6.5V
Max Input Current	20mA
Max Voltage VOUT to GND (10s)	±3.0V
ESD Tolerance (ISL28130)	
Human Body Model	3000V
Machine Model	200V
Charged Device Model	1500V
ESD Tolerance (ISL28230, ISL28430)	
Human Body Model	4000V
Machine Model	400V
Charged Device Model	2000V
Latch-Up Passed Per JESD78B	+125°C

Thermal Information

Thermal Resistance (Typical)	θ_{JA} (°C/W)	θ_{JC} (°C/W)
5 Ld SOT-23 (Notes 4, 5)	225	110
5 Ld SC70 (Notes 4, 5)	206	146
8 Ld SOIC (ISL28130CBZ) (Notes 4, 5)	135	95
8 Ld MSOP (Notes 4, 5)	180	65
8 Ld SOIC (ISL28230CBZ) (Notes 4, 5)	125	90
14 Ld TSSOP (Notes 4, 5)	110	40
14 Ld SOIC (Notes 4, 5)	75	47
Maximum Storage Temperature Range	-65°C to +150°C	
Pb-Free Reflow Profile	see link below http://www.intersil.com/pbfree/Pb-FreeReflow.asp	

Operating Conditions

Temperature Range 0°C to +70°C

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

- θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.
- For θ_{JC} , the "case temp" location is taken at the package top center.

Electrical Specifications $V_+ = 5V$, $V_- = 0V$, $V_{CM} = 2.5V$, $T_A = +25^\circ C$, $R_L = 10k\Omega$, unless otherwise specified. **Boldface limits apply over the operating temperature range, 0°C to +70°C.**

PARAMETER	DESCRIPTION	CONDITIONS	MIN (Note 6)	TYP	MAX (Note 6)	UNIT
DC SPECIFICATIONS						
V _{OS}	Input Offset Voltage	V _s = 1.65V to 5.5V	-40	±5	40	μV
			-46.8	-	46.8	μV
TCV _{OS}	Input Offset Voltage Temperature Coefficient		-150	20	150	nV/°C
I _{OS}	Input Offset Current		-	-60	-	pA
TCI _{OS}	Input Offset Current Temperature Coefficient		-	0.11	-	pA/°C
I _B	Input Bias Current		-250	-	250	pA
Common Mode Input Voltage Range		Guaranteed by CMRR	-0.1	-	5.1	V
CMRR	Common Mode Rejection Ratio	V _{CM} = -0.1V to 5.1V	110	125	-	dB
			105	-	-	dB
PSRR	Power Supply Rejection Ratio	V _s = 2.0V to 5.5V	105	138	-	dB
			105	-	-	dB
V _{OH}	Output Voltage Swing, High		4.950	4.981	-	V
V _{OL}	Output Voltage Swing, Low		-	18	50	mV
A _{OL}	Open Loop Gain	R _L = 1MΩ	-	150	-	dB
V ₊	Supply Voltage	Guaranteed by V _{OS}	1.65	-	5.5	V
I _S	Supply Current, Per Amplifier	R _L = OPEN	-	18	25	μA
			-	-	35	μA
I _{SC+}	Output Source Short Circuit Current	R _L = Short V-	-	15	-	mA

ISL28130, ISL28230, ISL28430

Electrical Specifications $V_+ = 5V$, $V_- = 0V$, $V_{CM} = 2.5V$, $T_A = +25^\circ C$, $R_L = 10k\Omega$, unless otherwise specified. **Boldface limits apply over the operating temperature range, $0^\circ C$ to $+70^\circ C$.** (Continued)

PARAMETER	DESCRIPTION	CONDITIONS	MIN (Note 6)	TYP	MAX (Note 6)	UNIT
I_{SC-}	Output Sink Short Circuit Current	$R_L = \text{Short } V_+$	-	-15	-	mA
AC SPECIFICATIONS						
GBWP	Gain Bandwidth Product	$A_V = 100$, $R_F = 100k\Omega$, $R_G = 1k\Omega$, $R_L = 10k\Omega$ to V_{CM}	-	400	-	kHz
$e_N V_{P-P}$	Peak-to-Peak Input Noise Voltage	$f = 0.01\text{Hz}$ to 10Hz	-	1.1	-	μV_{P-P}
e_N	Input Noise Voltage Density	$f = 1\text{kHz}$	-	65	-	$nV/\sqrt{\text{Hz}}$
i_N	Input Noise Current Density	$f = 1\text{kHz}$	-	72	-	$fA/\sqrt{\text{Hz}}$
		$f = 10\text{Hz}$	-	80	-	$fA/\sqrt{\text{Hz}}$
C_{in}	Differential Input Capacitance	$f = 1\text{MHz}$	-	1.6	-	pF
	Common Mode Input Capacitance		-	1.12	-	pF
TRANSIENT RESPONSE						
SR	Positive Slew Rate	$V_{OUT} = 1V$ to $4V$, $R_L = 10k\Omega$	-	0.2	-	$V/\mu s$
	Negative Slew Rate		-	0.1	-	$V/\mu s$
t_r , t_f , Small Signal	Rise Time, t_r 10% to 90%	$A_V = +1$, $V_{OUT} = 0.1V_{P-P}$, $R_F = 0\Omega$, $R_L = 10k\Omega$, $C_L = 1.2\text{pF}$	-	1.1	-	μs
	Fall Time, t_f 10% to 90%		-	1.1	-	μs
t_r , t_f Large Signal	Rise Time, t_r 10% to 90%	$A_V = +1$, $V_{OUT} = 2V_{P-P}$, $R_F = 0\Omega$, $R_L = 10k\Omega$, $C_L = 1.2\text{pF}$	-	20	-	μs
	Fall Time, t_f 10% to 90%		-	30	-	μs
t_s	Settling Time to 0.1%, $2V_{P-P}$ Step	$A_V = +1$, $R_F = 0\Omega$, $R_L = 10k\Omega$, $C_L = 1.2\text{pF}$	-	35	-	μs
$t_{recover}$	Output Overload Recovery Time, Recovery to 90% of output saturation	$A_V = +2$, $R_F = 10k\Omega$, $R_L = \text{Open}$, $C_L = 3.7\text{pF}$	-	10.5	-	μs

NOTE:

- Parameters with MIN and/or MAX limits are 100% tested at $+25^\circ C$, unless otherwise specified. Temperature limits established by characterization and are not production tested.

Typical Performance Curves

$V_+ = 5V$, $V_- = 0V$, $V_{CM} = 2.5V$, $R_L = \text{Open}$, $T = +25^\circ C$, unless otherwise specified.

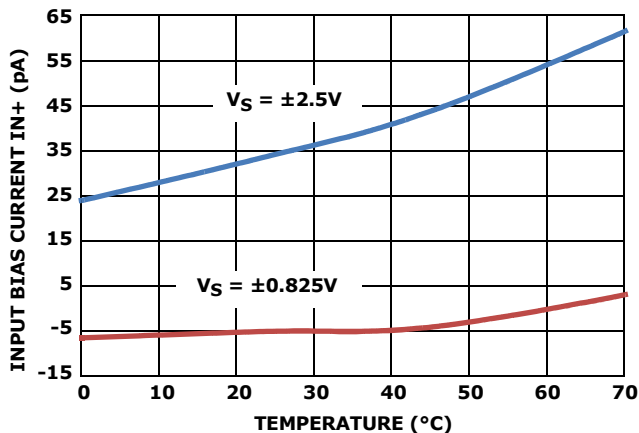


FIGURE 1. I_{B+} vs TEMPERATURE

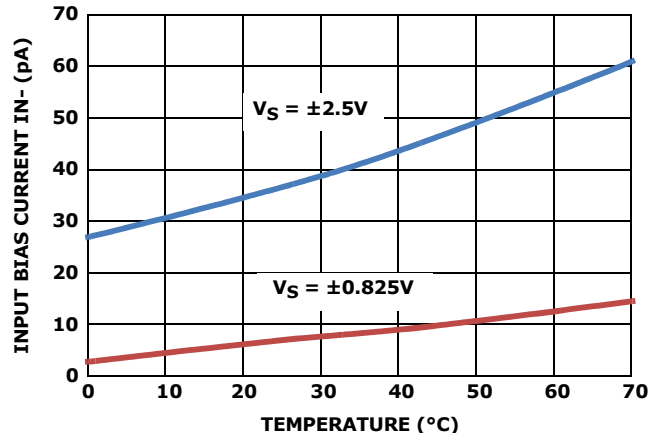


FIGURE 2. I_{B-} vs TEMPERATURE

Typical Performance Curves

$V_+ = 5V$, $V_- = 0V$, $V_{CM} = 2.5V$, $R_L = \text{Open}$, $T = +25^\circ\text{C}$, unless otherwise specified. (Continued)

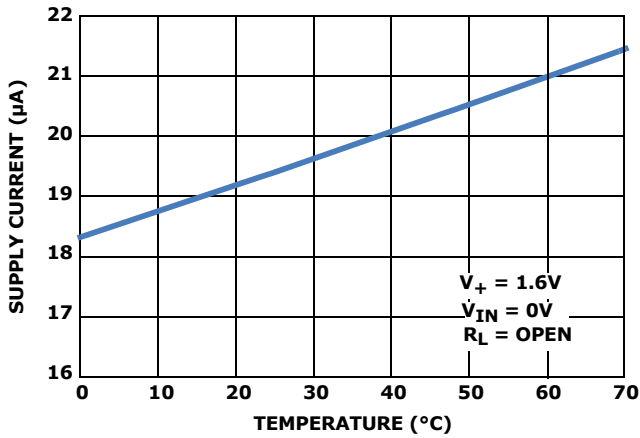


FIGURE 3. SUPPLY CURRENT vs TEMPERATURE

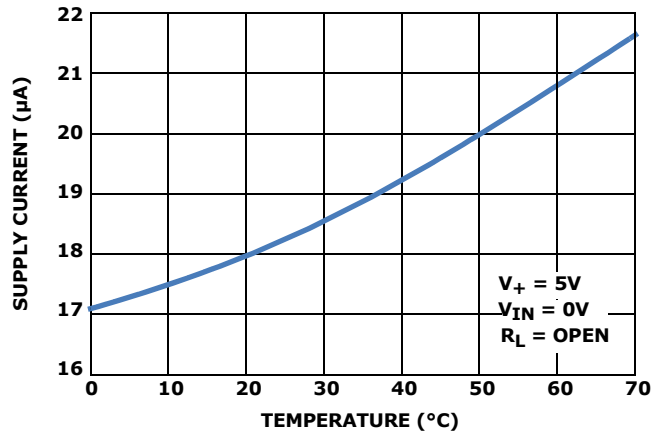


FIGURE 4. SUPPLY CURRENT vs TEMPERATURE

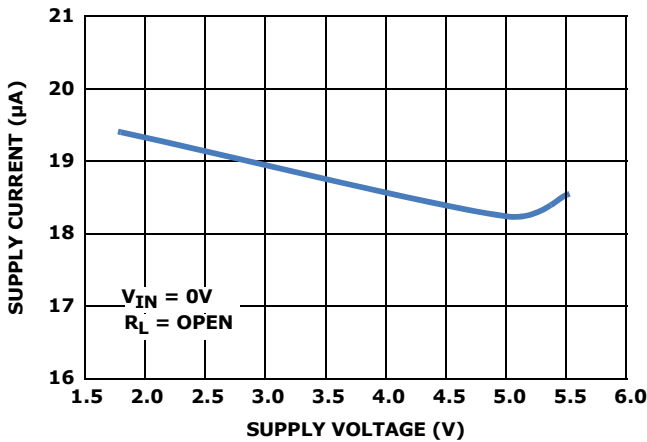


FIGURE 5. SUPPLY CURRENT vs SUPPLY VOLTAGE

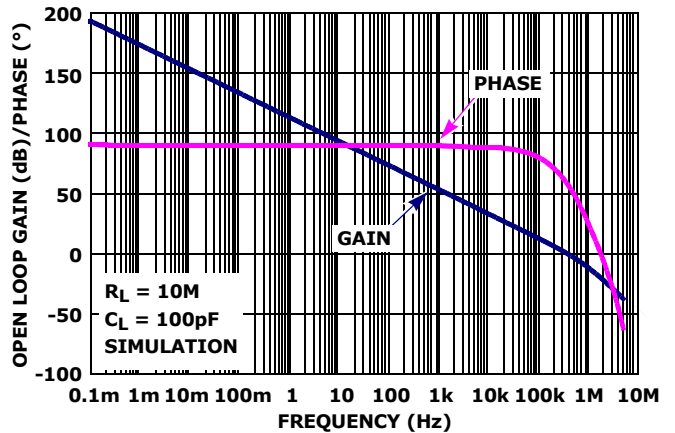


FIGURE 6. FREQUENCY RESPONSE vs OPEN LOOP GAIN, $R_L = 10M\Omega$

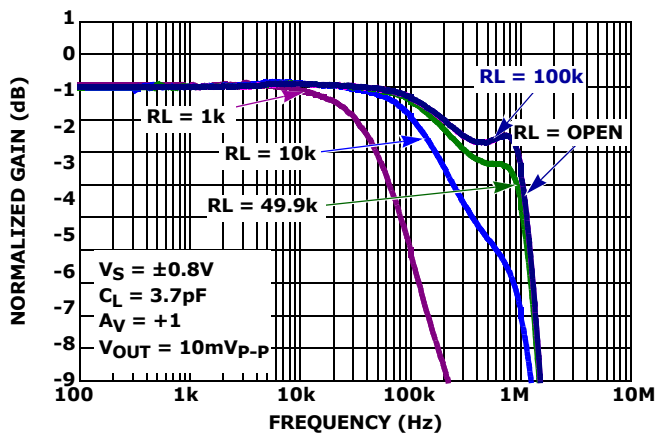


FIGURE 7. GAIN vs FREQUENCY vs R_L , $V_S = \pm 0.8V$

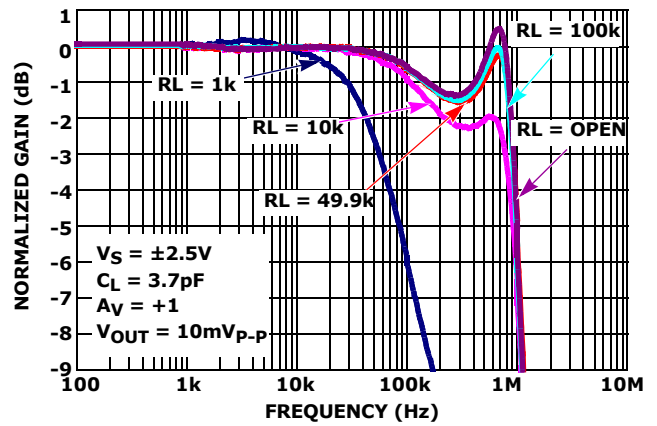


FIGURE 8. GAIN vs FREQUENCY vs R_L , $V_S = \pm 2.5V$

Typical Performance Curves

$V_+ = 5V$, $V_- = 0V$, $V_{CM} = 2.5V$, $R_L = \text{Open}$, $T = +25^\circ C$, unless otherwise specified. (Continued)

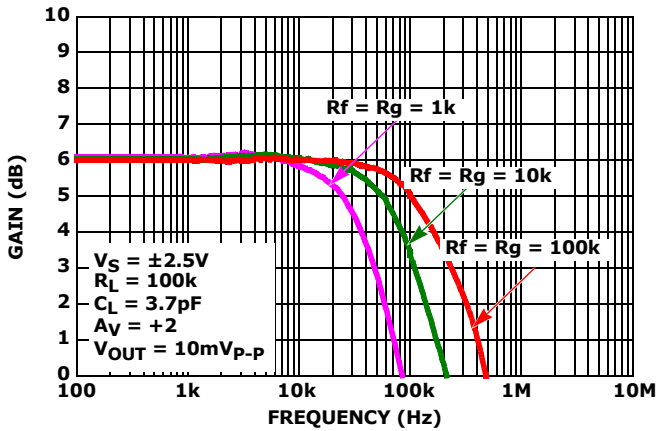


FIGURE 9. GAIN vs FREQUENCY vs FEEDBACK RESISTOR VALUES R_f/R_g

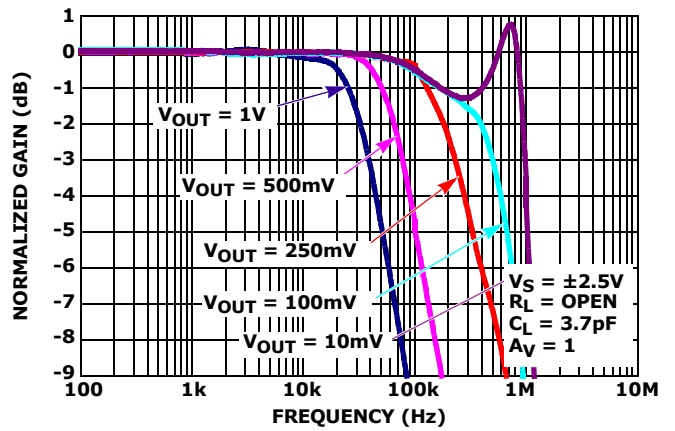


FIGURE 10. GAIN vs FREQUENCY vs V_{OUT}

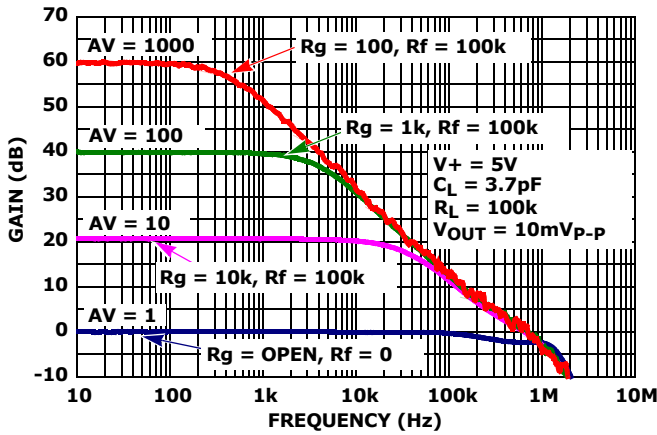


FIGURE 11. FREQUENCY RESPONSE vs CLOSED LOOP GAIN

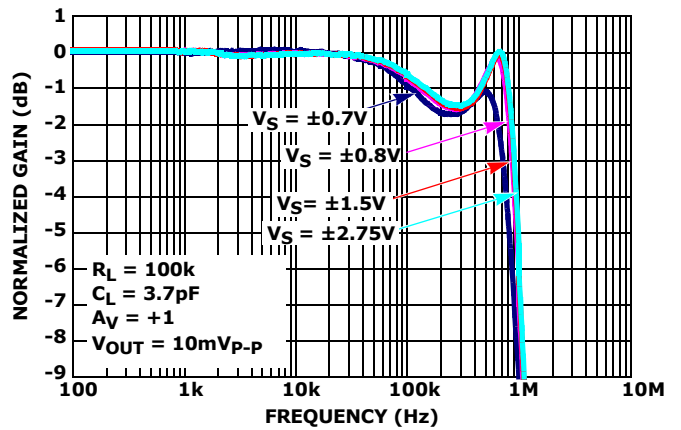


FIGURE 12. GAIN vs FREQUENCY vs SUPPLY VOLTAGE

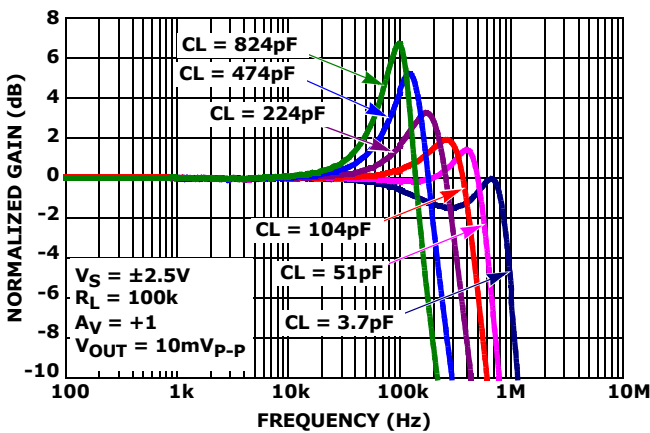


FIGURE 13. GAIN vs FREQUENCY vs C_L

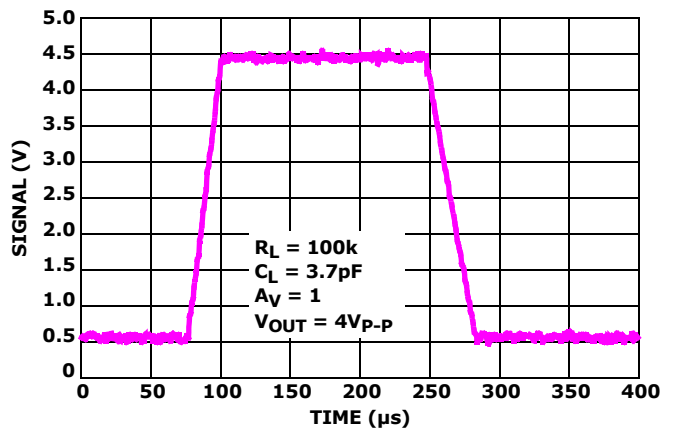


FIGURE 14. LARGE SIGNAL STEP RESPONSE (4V)

Typical Performance Curves

$V_+ = 5V$, $V_- = 0V$, $V_{CM} = 2.5V$, $R_L = \text{Open}$, $T = +25^\circ\text{C}$, unless otherwise specified. (Continued)

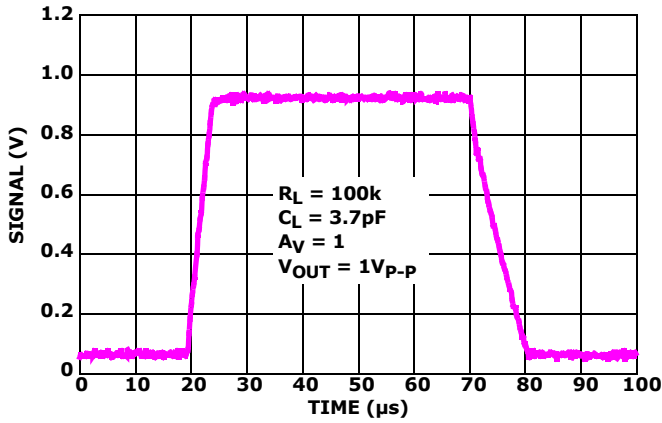


FIGURE 15. LARGE SIGNAL STEP RESPONSE (1V)

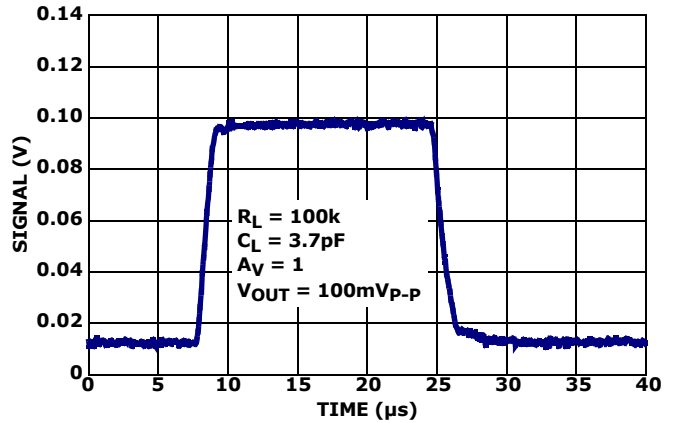


FIGURE 16. SMALL SIGNAL STEP RESPONSE (100mV)

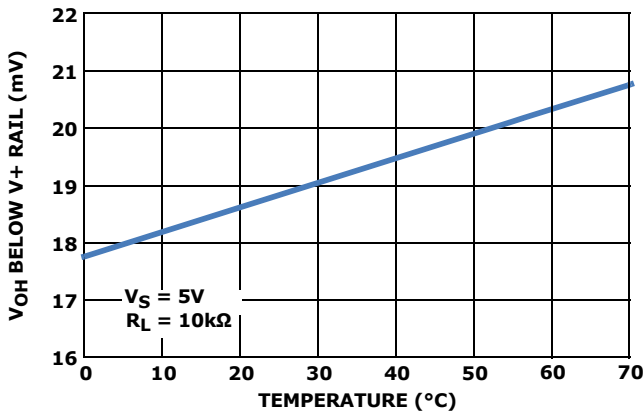


FIGURE 17. V_{OH} vs TEMPERATURE

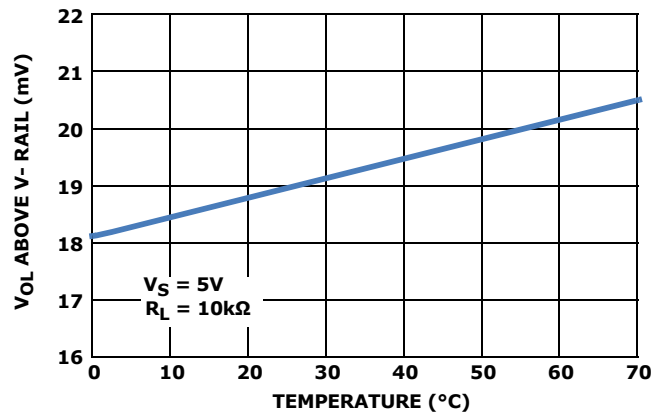


FIGURE 18. V_{OL} vs TEMPERATURE

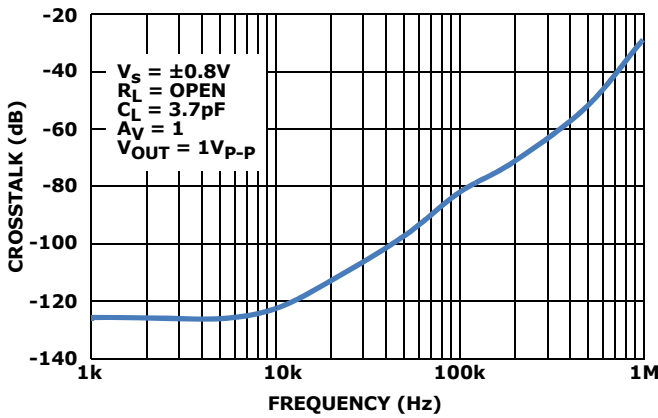


FIGURE 19. CROSSTALK vs FREQUENCY, $V_S = \pm 0.8V$

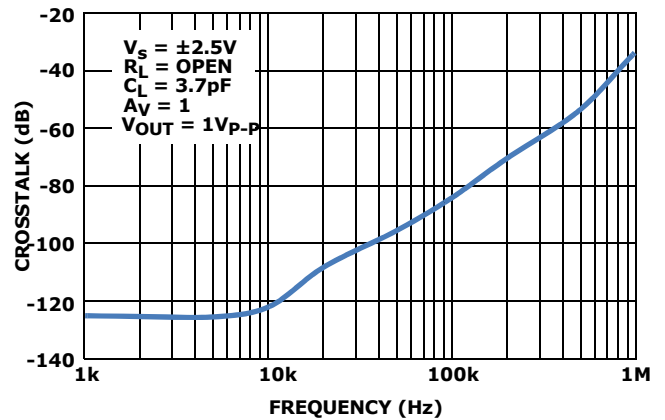


FIGURE 20. CROSSTALK vs FREQUENCY, $V_S = \pm 2.5V$

Applications Information

Functional Description

The ISL28130, ISL28230 and ISL28430 are low offset low drift operational amplifiers with a very high open loop gain (150dB). The ISL28130, ISL28230 and ISL28430 operate on a single supply range of 1.65V to 5.5V or dual supply range of $\pm 0.825\text{V}$ to $\pm 2.75\text{V}$ while consuming only $20\mu\text{A}$ of supply current per channel. The ISL28130, ISL28230 and ISL28430 has a 400kHz gain-bandwidth.

The high open loop gain, low offset voltage, high bandwidth and low 1/f noise make the ISL28130, ISL28230 and ISL28430 ideal for precision applications.

Rail-to-rail Input and Output (RRIO)

The RRIO CMOS amplifier uses parallel input PMOS and NMOS that enable the inputs to swing 100mV beyond either supply rail. The inverting and non-inverting inputs do not have back-to-back input clamp diodes and are capable of maintaining high input impedance at high differential input voltages. This is effective in eliminating output distortion caused by high slew-rate input signals.

The output stage uses common source connected PMOS and NMOS devices to achieve rail-to-rail output drive capability with 15mA current limit and the capability to swing to within 50mV of either rail while driving a 10k Ω load.

IN+ and IN- Protection

All input terminals have internal ESD protection diodes to both positive and negative supply rails, limiting the input voltage to within one diode beyond the supply rails. For applications where either input is expected to exceed the rails by 0.5V, an external series resistor must be used to ensure the input currents never exceed 20mA (see Figure 21).

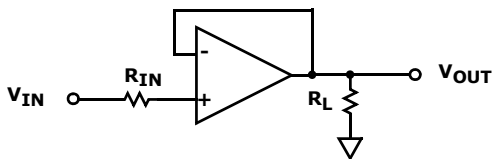


FIGURE 21. INPUT CURRENT LIMITING

Layout Guidelines for High Impedance Inputs

To achieve the maximum performance of the high input impedance and low offset voltage of the ISL28130, ISL28230 and ISL28430 amplifiers, care should be taken in the circuit board layout. The PC board surface must remain clean and free of moisture to avoid leakage currents between adjacent traces. Surface coating of the circuit board will reduce surface moisture and provide a humidity barrier, reducing parasitic resistance on the board.

High Gain, Precision DC-Coupled Amplifier

The circuit in Figure 22 implements a single-stage DC-coupled amplifier with an input DC sensitivity of under 100nV that is only possible using a low VOS amplifier with high open loop gain. High gain DC amplifiers operating from low voltage supplies are not practical using typical low offset precision op amps. For example, a typical precision amplifier in a gain of 10kV/V with a $\pm 100\mu\text{V}$ V_{OS} and offset drift $0.5\mu\text{V}/^\circ\text{C}$ of a low offset op amp would produce a DC error of $>1\text{V}$ with an additional $5\text{mV}/^\circ\text{C}$ of temperature dependent error making it difficult to resolve DC input voltage changes in the mV range.

The $\pm 40\mu\text{V}$ max V_{OS} and $150\text{nV}/^\circ\text{C}$ of temperature drift of the ISL28130, ISL28230, ISL28430 produces a temperature stable maximum DC output error of only $\pm 400\text{mV}$ with a maximum output temperature drift of $1.5\text{mV}/^\circ\text{C}$. The additional benefit of a very low 1/f noise corner frequency and some feedback filtering enables DC voltages and voltage fluctuations well below $10\mu\text{V}$ to be easily detected with a simple single stage amplifier.

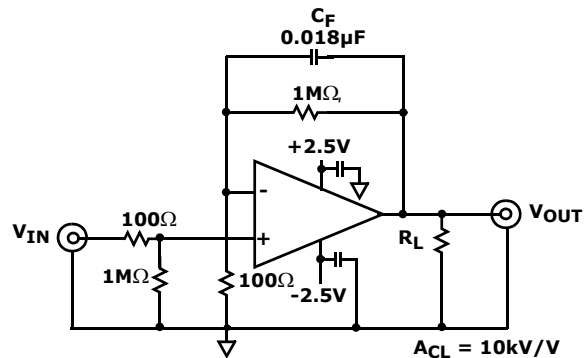


FIGURE 22. HIGH GAIN, PRECISION DC-COUPLED AMPLIFIER

Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest revision.

DATE	REVISION	CHANGE
8/17/10	FN7623.0	Initial Release

Products

Intersil Corporation is a leader in the design and manufacture of high-performance analog semiconductors. The Company's products address some of the industry's fastest growing markets, such as, flat panel displays, cell phones, handheld products, and notebooks. Intersil's product families address power management and analog signal processing functions. Go to www.intersil.com/products for a complete list of Intersil product families.

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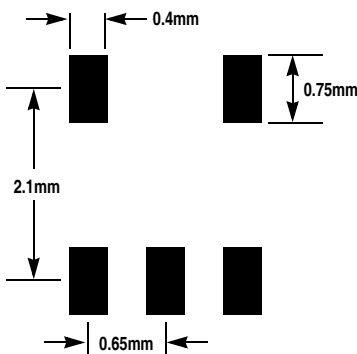
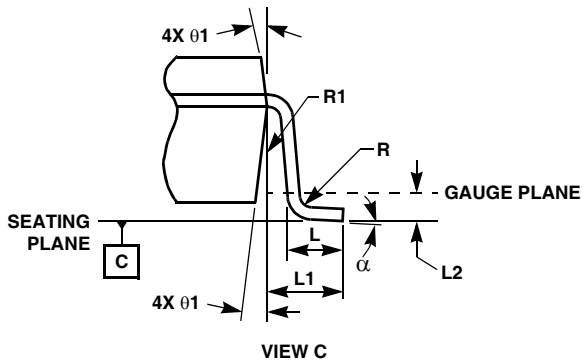
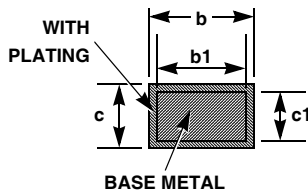
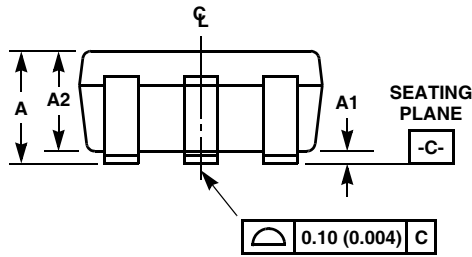
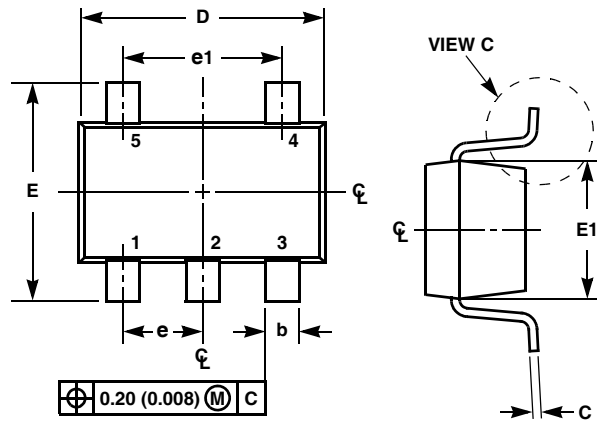
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Small Outline Transistor Plastic Packages (SC70-5)



TYPICAL RECOMMENDED LAND PATTERN

P5.049

5 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE

SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.031	0.043	0.80	1.10	-
A1	0.000	0.004	0.00	0.10	-
A2	0.031	0.039	0.80	1.00	-
b	0.006	0.012	0.15	0.30	-
b1	0.006	0.010	0.15	0.25	-
c	0.003	0.009	0.08	0.22	6
c1	0.003	0.009	0.08	0.20	6
D	0.073	0.085	1.85	2.15	3
E	0.071	0.094	1.80	2.40	-
E1	0.045	0.053	1.15	1.35	3
e	0.0256 Ref		0.65 Ref		-
e1	0.0512 Ref		1.30 Ref		-
L	0.010	0.018	0.26	0.46	4
L1	0.017 Ref.		0.420 Ref.		-
L2	0.006 BSC		0.15 BSC		-
α	0°	8°	0°	8°	-
N	5		5		5
R	0.004	-	0.10	-	-
R1	0.004	0.010	0.15	0.25	-

Rev. 3 7/07

NOTES:

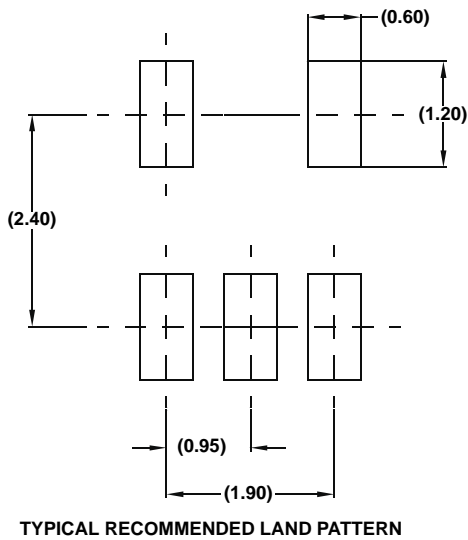
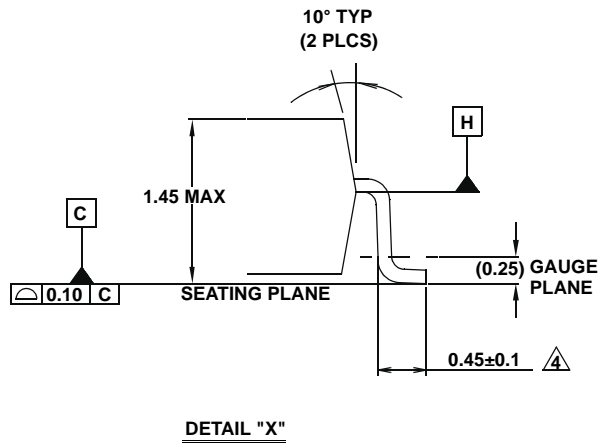
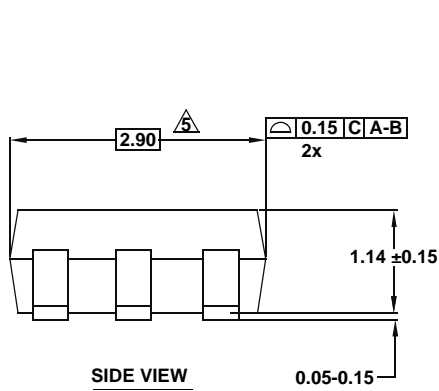
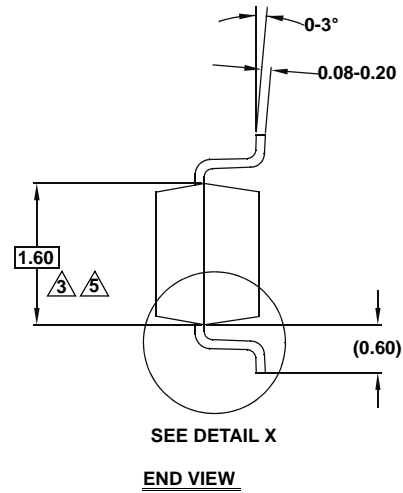
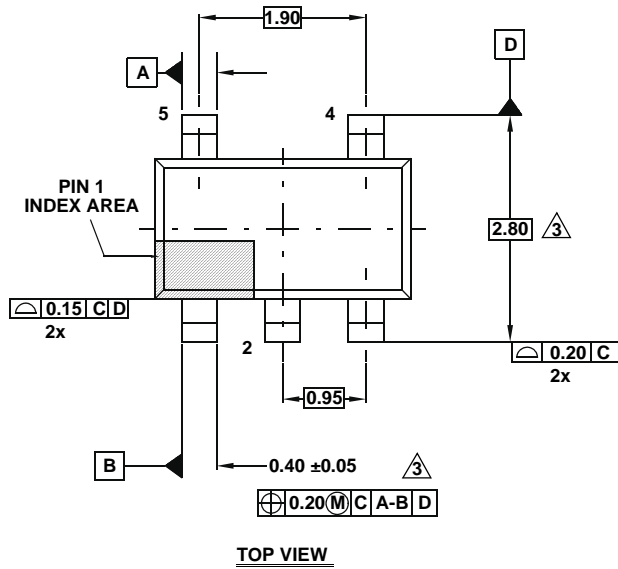
1. Dimensioning and tolerances per ASME Y14.5M-1994.
2. Package conforms to EIAJ SC70 and JEDEC MO-203AA.
3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
4. Footlength L measured at reference to gauge plane.
5. "N" is the number of terminal positions.
6. These Dimensions apply to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
7. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only.

Package Outline Drawing

P5.064A

5 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE

Rev 0, 2/10



NOTES:

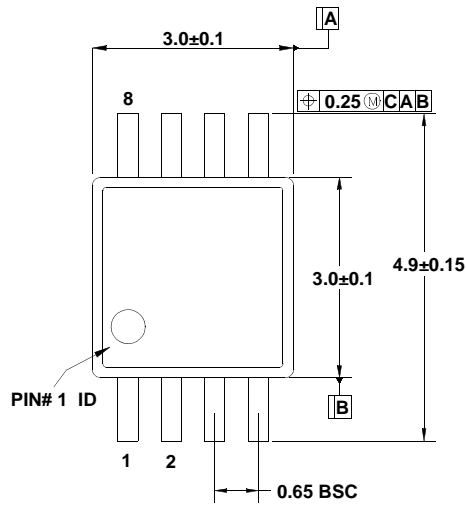
1. Dimensions are in millimeters.
Dimensions in () for Reference Only.
2. Dimensioning and tolerancing conform to ASME Y14.5M-1994.
3. Dimension is exclusive of mold flash, protrusions or gate burrs.
4. Foot length is measured at reference to gauge plane.
5. This dimension is measured at Datum "H".
6. Package conforms to JEDEC MO-178AA.

Package Outline Drawing

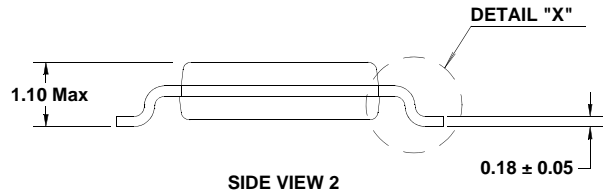
M8.118A

8 LEAD MINI SMALL OUTLINE PLASTIC PACKAGE (MSOP)

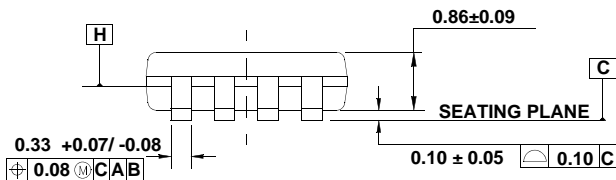
Rev 0, 9/09



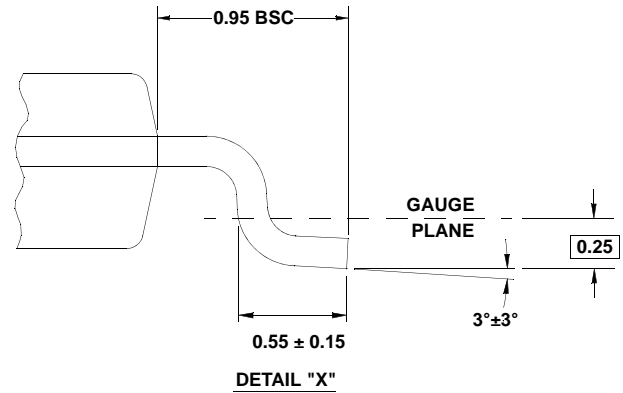
TOP VIEW



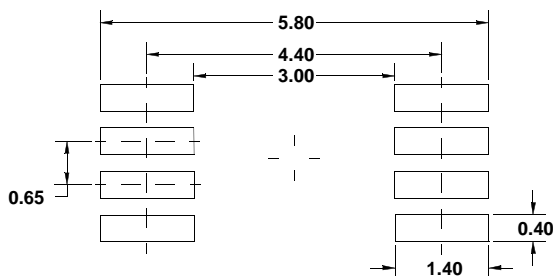
SIDE VIEW 2



SIDE VIEW 1



DETAIL "X"

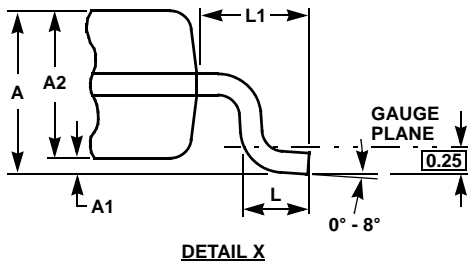
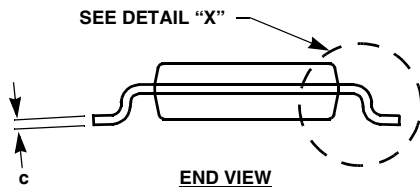
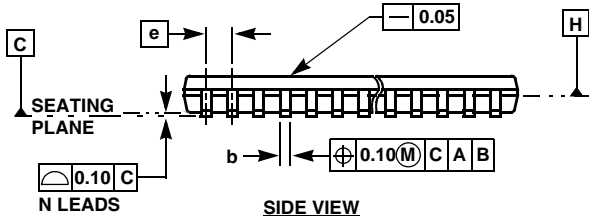
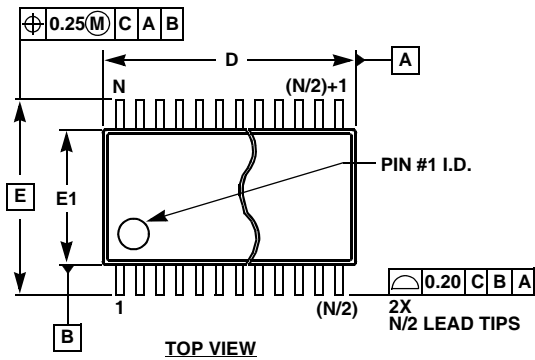


TYPICAL RECOMMENDED LAND PATTERN

NOTES:

1. Dimensions are in millimeters.
2. Dimensioning and tolerancing conform to JEDEC MO-187-AA and AMSE Y14.5m-1994.
3. Plastic or metal protrusions of 0.15mm max per side are not included.
4. Plastic interlead protrusions of 0.25mm max per side are not included.
5. Dimensions "D" and "E1" are measured at Datum Plane "H".
6. This replaces existing drawing # MDP0043 MSOP 8L.

Thin Shrink Small Outline Package Family (TSSOP)



MDP0044

THIN SHRINK SMALL OUTLINE PACKAGE FAMILY

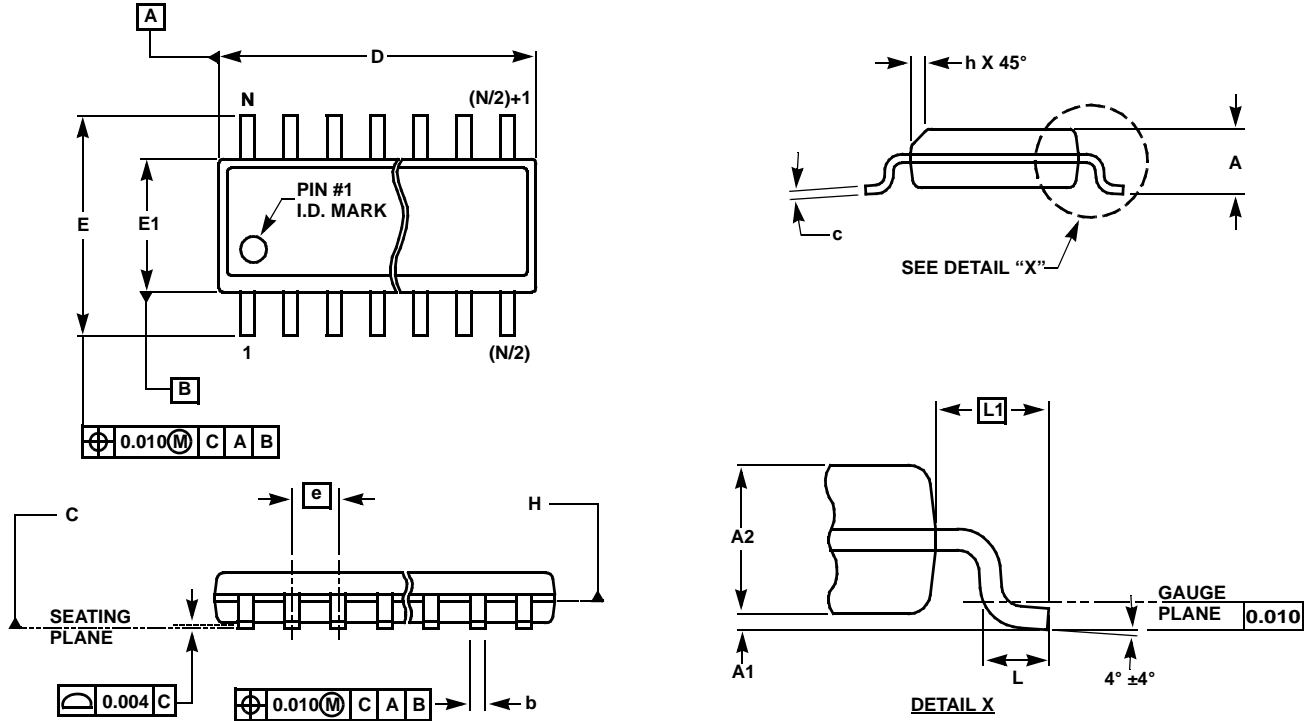
SYMBOL	MILLIMETERS					TOLERANCE
	14 LD	16 LD	20 LD	24 LD	28 LD	
A	1.20	1.20	1.20	1.20	1.20	Max
A1	0.10	0.10	0.10	0.10	0.10	±0.05
A2	0.90	0.90	0.90	0.90	0.90	±0.05
b	0.25	0.25	0.25	0.25	0.25	+0.05/-0.06
c	0.15	0.15	0.15	0.15	0.15	+0.05/-0.06
D	5.00	5.00	6.50	7.80	9.70	±0.10
E	6.40	6.40	6.40	6.40	6.40	Basic
E1	4.40	4.40	4.40	4.40	4.40	±0.10
e	0.65	0.65	0.65	0.65	0.65	Basic
L	0.60	0.60	0.60	0.60	0.60	±0.15
L1	1.00	1.00	1.00	1.00	1.00	Reference

Rev. F 2/07

NOTES:

1. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15mm per side.
2. Dimension "E1" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm per side.
3. Dimensions "D" and "E1" are measured at dAtum Plane H.
4. Dimensioning and tolerancing per ASME Y14.5M-1994.

Small Outline Package Family (SO)



MDP0027

SMALL OUTLINE PACKAGE FAMILY (SO)

SYMBOL	INCHES							TOLERANCE	NOTES
	SO-8	SO-14	SO16 (0.150")	SO16 (0.300") (SOL-16)	SO20 (SOL-20)	SO24 (SOL-24)	SO28 (SOL-28)		
A	0.068	0.068	0.068	0.104	0.104	0.104	0.104	MAX	-
A1	0.006	0.006	0.006	0.007	0.007	0.007	0.007	±0.003	-
A2	0.057	0.057	0.057	0.092	0.092	0.092	0.092	±0.002	-
b	0.017	0.017	0.017	0.017	0.017	0.017	0.017	±0.003	-
c	0.009	0.009	0.009	0.011	0.011	0.011	0.011	±0.001	-
D	0.193	0.341	0.390	0.406	0.504	0.606	0.704	±0.004	1, 3
E	0.236	0.236	0.236	0.406	0.406	0.406	0.406	±0.008	-
E1	0.154	0.154	0.154	0.295	0.295	0.295	0.295	±0.004	2, 3
e	0.050	0.050	0.050	0.050	0.050	0.050	0.050	Basic	-
L	0.025	0.025	0.025	0.030	0.030	0.030	0.030	±0.009	-
L1	0.041	0.041	0.041	0.056	0.056	0.056	0.056	Basic	-
h	0.013	0.013	0.013	0.020	0.020	0.020	0.020	Reference	-
N	8	14	16	16	20	24	28	Reference	-

Rev. M 2/07

NOTES:

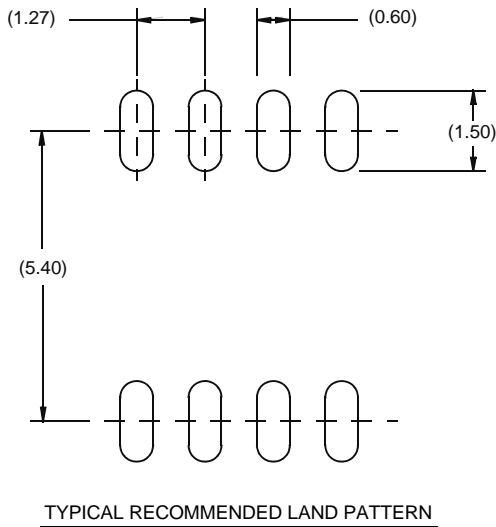
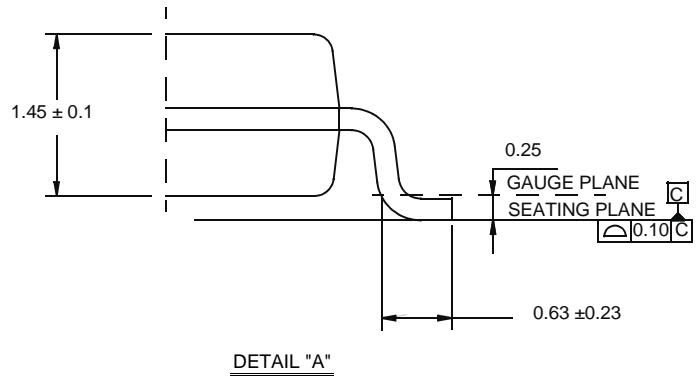
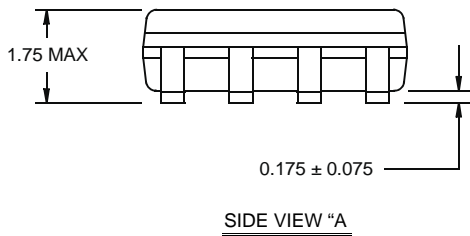
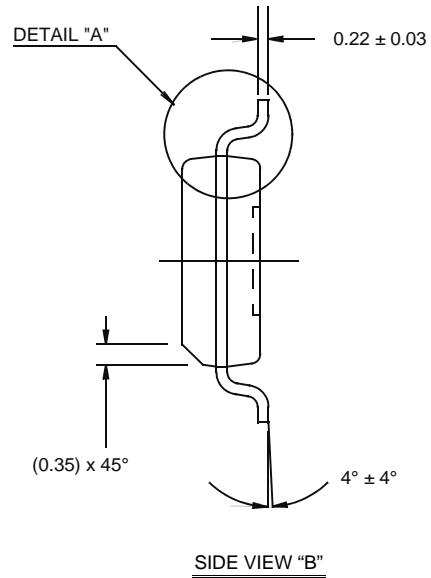
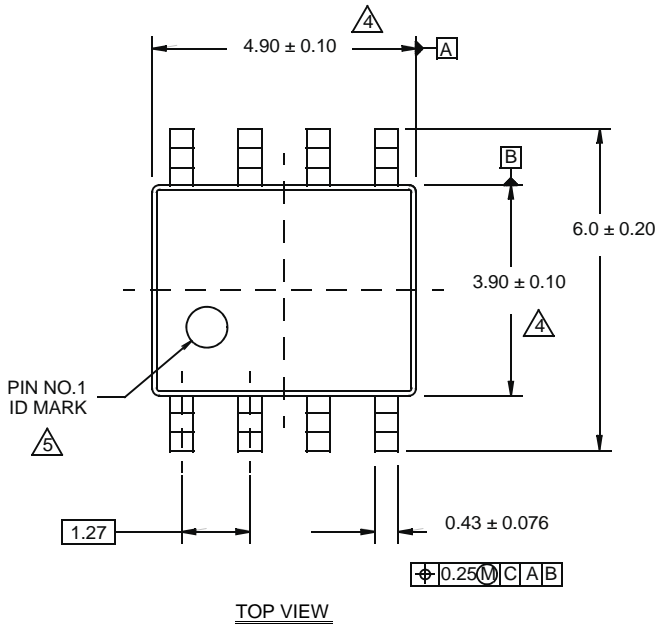
1. Plastic or metal protrusions of 0.006" maximum per side are not included.
2. Plastic interlead protrusions of 0.010" maximum per side are not included.
3. Dimensions "D" and "E1" are measured at Datum Plane "H".
4. Dimensioning and tolerancing per ASME Y14.5M-1994

Package Outline Drawing

M8.15E

8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

Rev 0, 08/09



NOTES:

1. Dimensions are in millimeters.
Dimensions in () for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal ± 0.05
4. Dimension does not include interlead flash or protrusions.
Interlead flash or protrusions shall not exceed 0.25mm per side.
5. The pin #1 identifier may be either a mold or mark feature.
6. Reference to JEDEC MS-012.